

INTERNATIONAL STANDARD

Synthetic quartz crystal – Specifications and guidelines for use





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INTERNATIONAL STANDARD

Synthetic quartz crystal – Specifications and guidelines for use

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**SYNTHETIC QUARTZ CRYSTAL –
SPECIFICATIONS AND GUIDELINES FOR USE**

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International Standard IEC 60758 has been prepared by IEC technical committee 49: Piezoelectric, dielectric and electrostatic devices and associated materials for frequency control, selection and detection.

This fifth edition cancels and replaces the fourth edition, published in 2008. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- order rearrangement and review of terms and definitions;
- abolition as a standard of the infrared absorbance coefficient $\alpha_{3.410}$;
- addition of the α value measurement explanation by FT-IR equipment in annex;
- addition of the synthetic quartz crystal standards for optical applications.

The text of this standard is based on the following documents:

FDIS	Report on voting
49/1185/FDIS	49/1190/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

INTRODUCTION

The reason for adding synthetic quartz crystal for optical application to this International Standard is as follows.

Quartz crystal produced for optical applications is produced by many of the same suppliers manufacturing quartz for electronic applications. The equipment and methods to produce optical quartz are similar to those used in the production of electronic quartz. Also, with a few exceptions the characterization methods of electronic and optical material are similar. Therefore, IEC 60758 serves as the proper basis for including addenda related to quartz crystal for optical applications.

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SYNTHETIC QUARTZ CRYSTAL – SPECIFICATIONS AND GUIDELINES FOR USE

1 Scope

This International Standard applies to synthetic quartz single crystals intended for manufacturing piezoelectric elements for frequency control, selection and optical applications.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-1:2013, *Environmental testing – Part 1: General and guidance*

IEC 60122-1:2002, *Quartz crystal units of assessed quality – Part 1: Generic specification*

IEC 60410, *Sampling plans and procedures for inspection by attributes*

IEC 61994 (all parts), *Piezoelectric and dielectric devices for frequency control and selection – Glossary*

3 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 61994 and the following apply.

3.1

hydrothermal crystal growth

crystal growth in the presence of water, elevated temperatures and pressures by a crystal growth process believed to proceed geologically within the earth's crust

Note 1 to entry: The industrial synthetic quartz growth processes utilize alkaline water solutions confined within autoclaves at supercritical temperatures (330 °C to 400 °C) and pressures (700 to 2 000 atmospheres).

Note 2 to entry: The autoclave is divided into two chambers: the dissolving chamber, containing raw quartz chips at the higher temperature; the growing chamber, containing cut seeds at the lower temperature (see 7.1.2).

3.2

synthetic quartz crystal

single crystal of α quartz grown by the hydrothermal method

Note 1 to entry: Cultured quartz has the same meaning as synthetic quartz crystal.

3.3

as-grown synthetic quartz crystal

state of synthetic quartz crystal prior to grinding or cutting

3.4

as-grown Y-bar

crystals which are grown by using long stick seed in the Y-direction